

Session 7

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HIGH FREQUENCY DEVELOPMENTS

"Challenging Device Interface -For High Speed DIMM Module Testing" Joachim Moerbt, Rose Hu Advantest (Europe) GmbH

"Tolerance Induced Test Socket RF Performance Variation" Gert Hohenwarter GateWave Northern, Inc.

"From Single-Ended to Differential" Ryan Satrom Everett Charles Technologies

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ADVANTEST

Challenging Device Interface

for High speed DIMM Module Testing

2008 Burn-in and Test Socket Workshop March 9 - 12, 2008



Joachim Moerbt Rose Hu

Advantest (Europe) GmbH















































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Bits 2008

High Frequency Developments



























DRAM Modules can be tested highly parallel up to 400 MHz using ATE and flexible Device Interfaces

> Special thanks to Mrs. Rose Hu, co-author and project leader Flex DIMM HiFix development

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2008 Burn-in and Test Socket Workshop GateWave Northern Inco. March 9 - 12, 2008



Gert Hohenwarter GateWave Northern, Inc. www.gatewave.com





























Inductance change example



































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High Frequency Developments





































Advantages/Disadvantages of Differential Signaling

- Advantages
 - Increased immunity to return path discontinuities
 - Less susceptible to noise
- Disadvantages
 - Requires additional PCB real estate
 - Possibility of creating increased EMI

From Single-Ended to Differential











Single-Ended vs. Differential Performance

- Differential signals will not perform like single-ended signals in contactors
- Differential signal configuration always differs from single-ended configuration, affecting performance
- In order to understand contactor performance, differential specifications must be obtained from supplier
- Characterization is required for each configuration

From Single-Ended to Differential







Comparison of single-ended G-S-G vs. differential G-S-S-G • Case #2 - BTM050 @ 0.8mm - Bandwidth increases







Single-Ended vs. Differential Performance

- Results Summary
 - Case #1 Bandwidth is unchanged
 - Case #2 Bandwidth increases
 - Case #3 Bandwidth decreases
- There is no trend to predict differential performance based on single-ended performance

From Single-Ended to Differential

























PCB-Contactor Transition	
Results Summary	
 Single-Ended – Bandwidth decreases significantly Differential – Bandwidth less affected 	
 PCB-contactor transitions will have less effect on differential signals than single-ended signals 	
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